

Light Avenue Premium Edition LED series is designed for high performance consumer applications. Remarkable light extraction is reached by a particular top emitting design with vertical chip structure. As this die can be driven at very high currents compared to the chip size, an outstanding cost vs. performance ratio can be obtained.



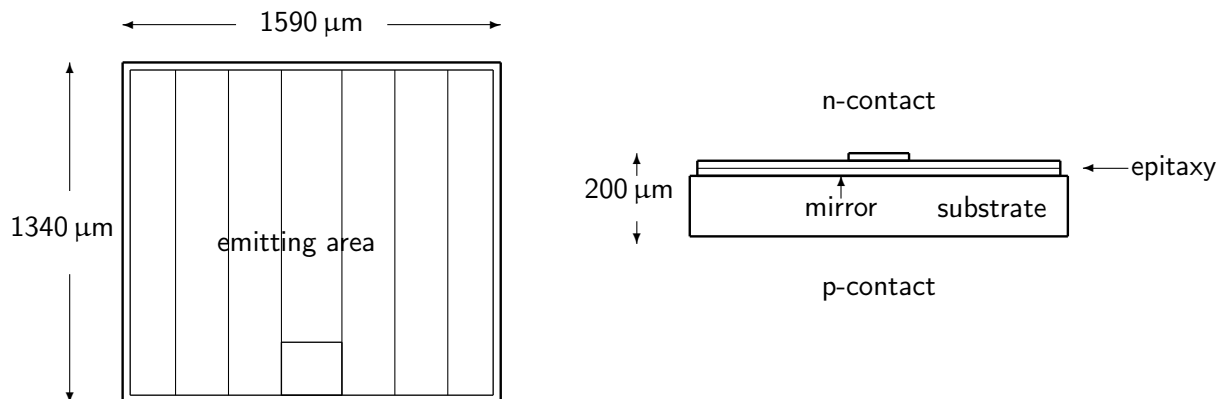
### Features

- Top emitting device
- Lambertian radiation
- Optimized for SMT applications
- Grouping: luminous intensity, wavelength

### Applications

- Solid state lighting
- LCD backlighting
- Displays
- Lamps
- Light indicators

### Delineation



### Mechanical characteristics

DESCRIPTION	MINIMUM	TYPICAL <sup>1</sup>	MAXIMUM
Chip size (μm)	1550x1300	1590x1340	1650x1400
Chip height (μm)	170	190	210
Bond pad diameter (μm)	160x210	190x240	220x270
Top contact	Cathode (n), gold		
Bottom contact	Anode (p), AuSn		
Die attach	Soldering		

Electro-optical characteristics ( $T_A = 25^\circ\text{C}$ )<sup>2</sup>

PARAMETER	SYMBOL	CONDITION	MIN.	TYP. <sup>1</sup>	MAX.	UNIT
Forward voltage	$V_F$	$I_F = 1000\text{ mA}$	2.80		4.20	V
Reverse voltage	$V_R$	$I_R = 10\ \mu\text{A}$	5.0			V
Dominant wavelength	$\lambda_{dom}$	$I_F = 1000\text{ mA}$	515		537.5	nm
Luminous intensity	$I_v$	$I_F = 1000\text{ mA}$	32000	50000		mcd

Maximum ratings ( $T_A = 25^\circ\text{C}$ )<sup>3</sup>

PARAMETER	SYMBOL	VALUE	UNIT
Operating temperature range	$T_{op}$	-40...+85	°C
Forward current	$I_F$	1500	mA
LED junction temperature	$T_j$	125	°C

Binning ( $I_F = 1000\text{ mA}$ )<sup>4</sup>

		WAVELENGTH (NM)							
		515-520	517.5-522.5	520-522.5	522.5-527.5	522.5-530	527.5-532.5	530-535	532.5-537.5
Luminous intensity (mcd)	> 32000	A52	AM52	B52	BM52	C52	CM52	D52	DM52
	> 40000	A53	AM53	B53	BM53	C53	CM53	D53	DM53
	> 50000	A54	AM54	B54	BM54	C54	CM54	D54	DM54
	> 64000	A55	AM55	B55	BM55	C55	CM55	D55	DM55

Notes:

- The usage of LEDs in life-support devices or systems has to be expressly and written authorized by the supplier!
- Dice are sensitive to ESD.
- Dice are shipped on blue foil with or without frame and have therefore to be stored between 15 and 30°C and below 60% relative humidity.
- Lead free product - RoHS compliant.
- The information in this document is subject to change without notice and describes the die generally. It shall not be considered as assured characteristics or detailed specification.

- The quality level of the final visual inspection shall comply to an AQL of 1.0 (according to MIL-STD-105E, level II), if the customer performs an incoming visual inspection of a shipment.
- All chips are checked according to the "Failure Catalog of Light Avenue dice" dated 2009-11-14. If this document is not familiar to you, please request it at your next sales office.

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<sup>1</sup>Typical (Typ) data are defined as long-term production mean values. These values are not specified and only given for information.

<sup>2</sup>Measurements are done with an accuracy of  $\pm 15\%$ . Correlation to customer's equipment and products is required.

<sup>3</sup>Maximum ratings are package dependent and may differ between packages. The forward current is not limited by the die but by the effect of the LED junction temperature on the package. If you need more information on pulsed operation, please contact your next sales office about possible driving conditions. If not otherwise specified the maximum pulse current may not exceed the maximum current in continuous mode.

<sup>4</sup>There may be more than one bin on one single foil. Single bins cannot be ordered.